2SB1028

Silicon PNP Epitaxial

HITACHI

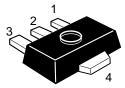
ADE-208-1039 (Z) 1st. Edition Mar. 2001

Application

Low frequency power amplifier

Outline

UPAK



- 1. Base
- 2. Collector
- 3. Emitter
- 4. Collector (Flange)



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Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Collector to base voltage	V_{CBO}	-180	V
Collector to emitter voltage	V _{CEO}	-160	V
Emitter to base voltage	V_{EBO}	- 5	V
Collector current	I _c	-1.5	A
Collector peak current	i _{C(peak)} *1	-3	A
Collector power dissipation	P _C *2	1	W
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW ≤ 10 ms, Duty cycle ≤ 20%

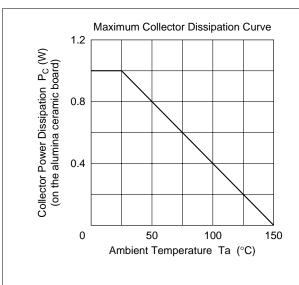
2. Value on the alumina ceramic board (12.5 \times 20 \times 0.7 mm)

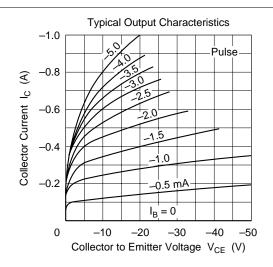
Electrical Characteristics ($Ta = 25^{\circ}C$)

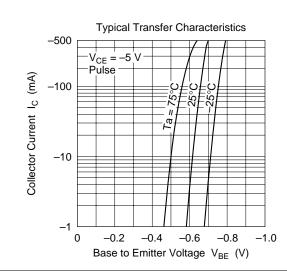
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{\text{(BR)CBO}}$	-180	_	_	V	$I_C = -1 \text{ mA}, I_E = 0$
Collector to emitter breakdown voltage	$V_{\text{(BR)CEO}}$	-160	_	_	V	$I_{C} = -10 \text{ mA}, R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	- 5	_	_	V	$I_E = -1 \text{ mA}, I_C = 0$
Collector cutoff current	I _{CBO}	_	_	-10	μΑ	$V_{CB} = -160 \text{ V}, I_{E} = 0$
DC current transfer ratio	h _{FE1} *1	60	_	200		$V_{CE} = -5 \text{ V}, I_{C} = -0.15 \text{ A},$ pulse
	h _{FE2}	30	_	_		$V_{CE} = -5 \text{ V}, I_{C} = -0.5 \text{ A},$ pulse
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	_	_	-1.0	V	$I_C = -0.5 \text{ A}, I_B = -50 \text{ mA},$ Pulse
Base to emitter voltage	V_{BE}	_	_	-0.9	V	$V_{CE} = -5 \text{ V}, I_{C} = -0.15 \text{ A},$ pulse

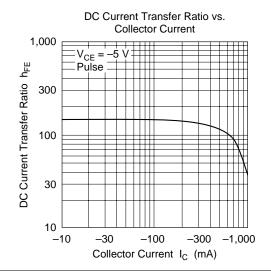
Note: 1. The 2SB1028 is grouped by h_{FE1} as follows.

Mark	EL	EM
h _{FE1}	60 to 120	100 to 200

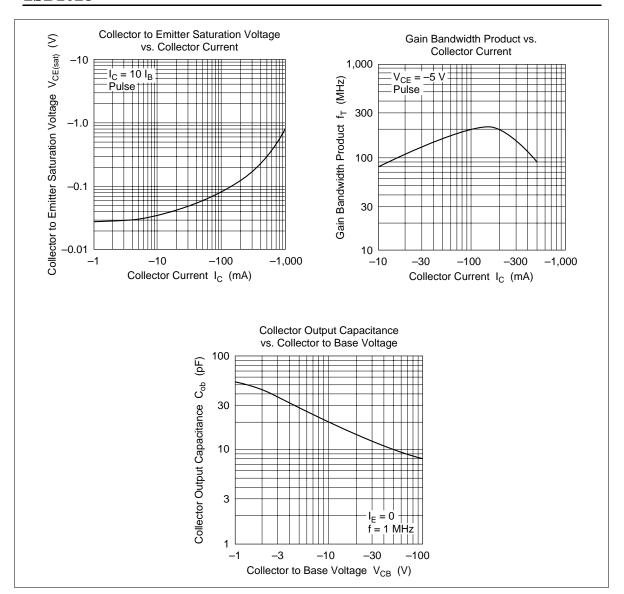




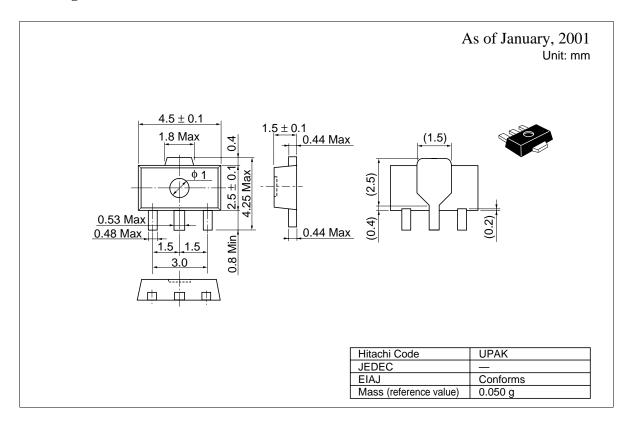




2SB1028



Package Dimensions



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